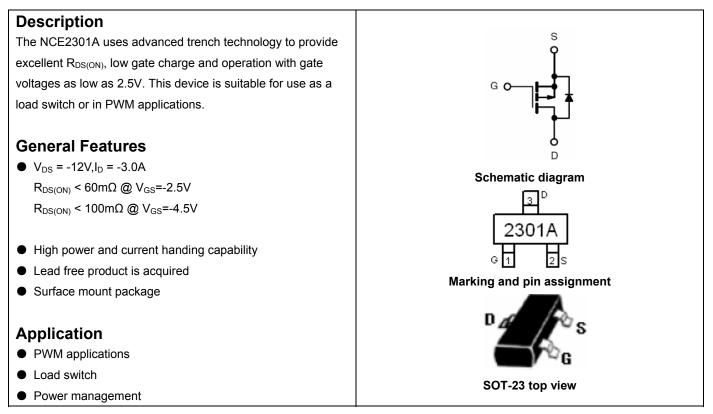


# NCE P-Channel Enhancement Mode Power MOSFET



### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2301A	NCE2301A	SOT-23	Ø180mm	8 mm	3000 units

### Absolute Maximum Ratings (T<sub>A</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-12	V
Gate-Source Voltage	Vgs	±12	V
Drain Current-Continuous	I <sub>D</sub>	-3.0	А
Drain Current -Pulsed (Note 1)	I <sub>DM</sub>	-15	А
Maximum Power Dissipation	PD	1	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C

### **Thermal Characteristic**

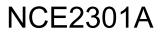
Thermal Resistance, Junction-to-Ambient (Note 2)	R <sub>θJA</sub>	125	°C <b>/W</b>
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#### Electrical Characteristics (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-12	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =-12V, $V_{GS}$ =0V	-	-	-1	μA







Parameter	Symbol	Condition	Min	Тур	Max	Unit
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±12V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-0.4	-0.7	-1	V
Drain Course On State Desistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2.5A	-	42	60	mΩ
Drain-Source On-State Resistance		$V_{GS}$ =-2.5V, $I_D$ =-2A	-	47	100	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-5V,I <sub>D</sub> =-2A	5	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C <sub>lss</sub>	(1 - 40)(1)(-0)(	-	405	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =-10V,V <sub>GS</sub> =0V, F=1.0MHz	-	112	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	89	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	11	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =-10V, R <sub>L</sub> =2.9Ω	-	35	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-4.5V, $R_{GEN}$ =10 $\Omega$	-	30	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	Qg	)/ <u>40)/</u> ] 0.54	-	9	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =-10V,I <sub>D</sub> =-2.5A,	-	1.0	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	$V_{GS}$ =-4.5V	-	2.5	_	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	$V_{GS}$ =0V,I <sub>S</sub> =-3.0A	-	-	-1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	-3.0	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t  $\leq$  10 sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production



NCE2301A



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# **Typical Electrical and Thermal Characteristics**

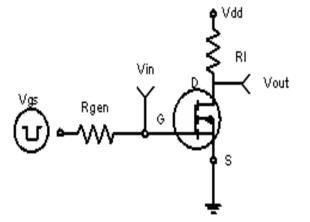
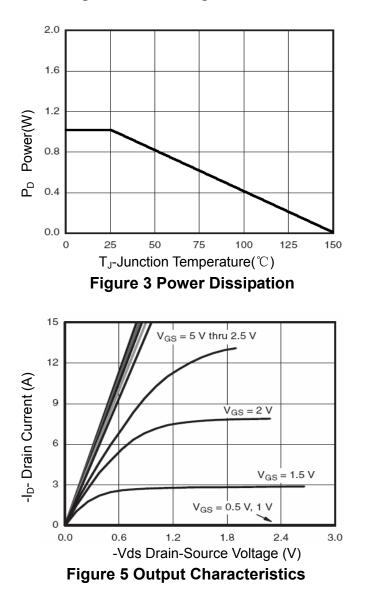
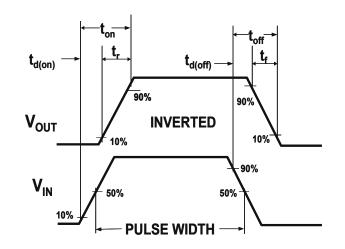
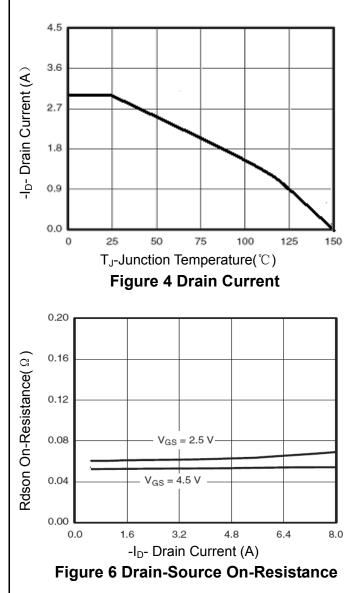


Figure 1:Switching Test Circuit





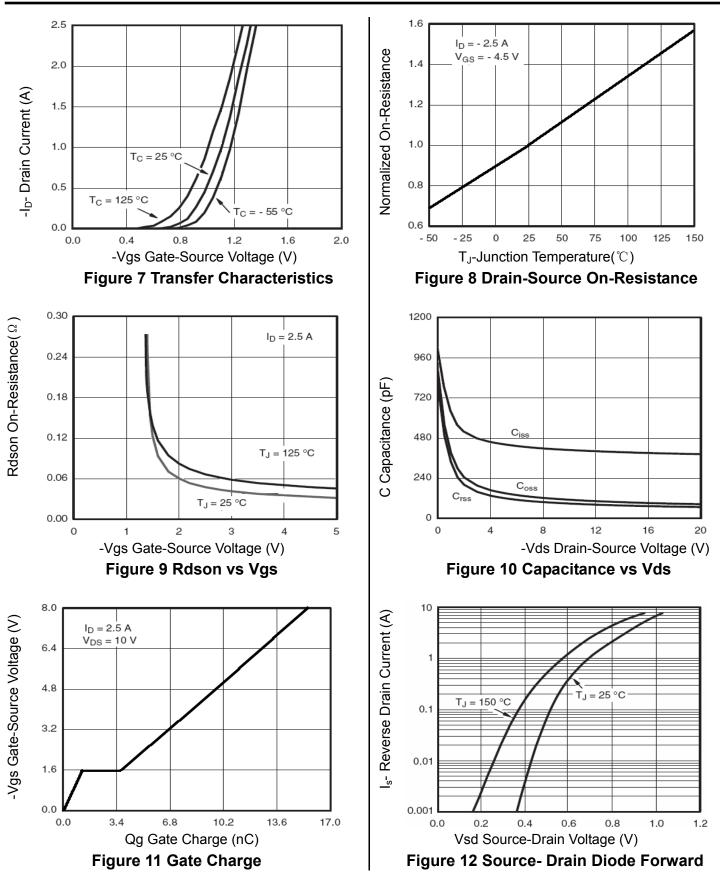








NCE2301A







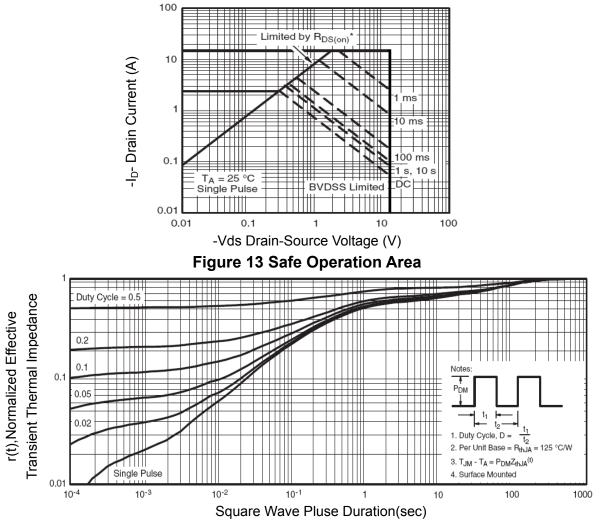
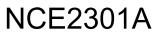
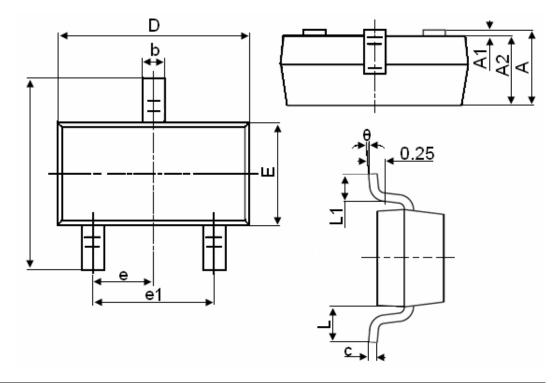


Figure 14 Normalized Maximum Transient Thermal Impedance





# **SOT-23 Package Information**



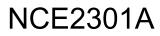
Symbol		Dimensions in Millimeters	
Symbol	MIN.	MAX.	
A	0.900	1.150	
A1	0.000	0.100	
A2	0.900	1.050	
b	0.300	0.500	
с	0.080	0.150	
D	2.800	3.000	
E	1.200	1.400	
E1	2.250	2.550	
е		0.950TYP	
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.500	
θ	0°	8°	

### Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.







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